Hex inverter with open-drain outputs Rev. 1 — 9 July 2012

Product data sheet

#### 1. **General description**

The 74HC05-Q100 is a high-speed Si-gate CMOS device that complies with JEDEC standard no. 7A.

The 74HC05-Q100 contains six inverters. The outputs of the 74HC05-Q100 are open-drain and can be connected to other open-drain outputs to implement active-LOW wired-OR or active-HIGH wired-AND functions. The open-drain outputs require pull-up resistors to perform correctly.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

#### **Features and benefits** 2.

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - Specified from –40 °C to +85 °C and from –40 °C to +125 °C
- Wide operating voltage 2.0 V to 6.0 V
- Input levels:
  - For 74HC05-Q100: CMOS level
- Latch-up performance exceeds 100 mA per JESD 78 Class II level A
- ESD protection:
  - MIL-STD-883, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V (C = 200 pf, R = 0 Ω)
- Multiple package options

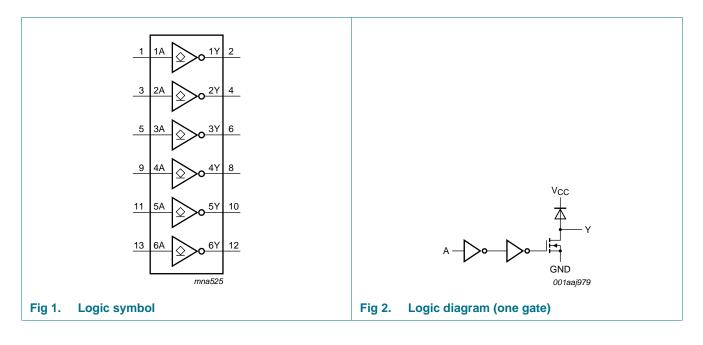


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## 3. Ordering information

Table 1. Orderin	Table 1. Ordering information				
Type number	Package				
	Temperature range	Name	Description	Version	
74HC05D-Q100	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1	
74HC05PW-Q100	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1	
74HC05BQ-Q100	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm	SOT762-1	

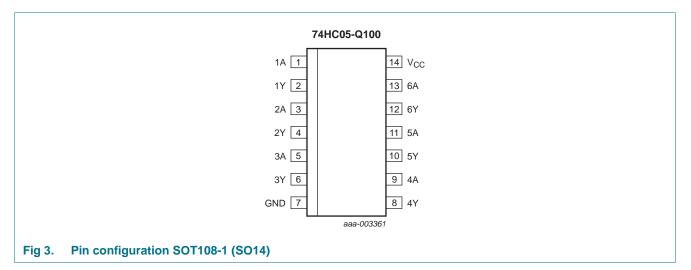
## 4. Functional diagram

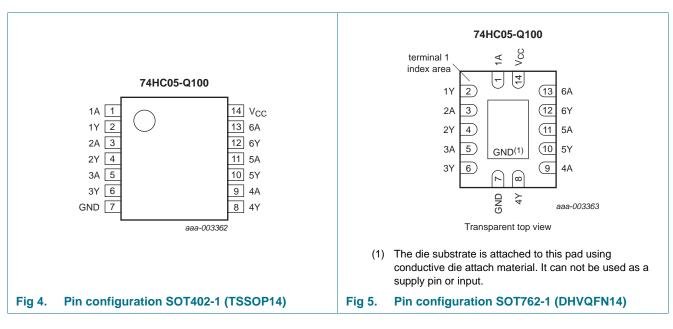


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#### **Pinning information** 5.

### 5.1 Pinning





### 5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
1A to 6A	1, 3, 5, 9, 11, 13	data input
1Y to 6Y	2, 4, 6, 8, 10, 12	data output
GND	7	ground (0 V)
V <sub>CC</sub>	14	supply voltage

74HC05\_Q100 **Product data sheet** 

#### **Functional description** 6.

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Table 3.    Function table <sup>[1]</sup>	
Input	Output
nA	nY
L	Z
Н	L

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

#### **Limiting values** 7.

#### Table 4. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_{\rm I}$ < –0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
Vo	output voltage		<u>[1]</u> –0.5	V <sub>CC</sub> + 0.5 V	V
lo	output current	$V_{\rm O} < V_{\rm CC} + 0.5 \ V$	-	25	mA
I <sub>CC</sub>	supply current		-	50	mA
I <sub>GND</sub>	ground current		-50	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation		[2] _	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SO14 package: Ptot derates linearly with 8 mW/K above 70 °C.

For TSSOP14 packages: Ptot derates linearly with 5.5 mW/K above 60 °C. For DHVQFN14 packages: Ptot derates linearly with 4.5 mW/K above 60 °C.

#### **Recommended operating conditions** 8.

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V) Symbol Parameter Conditions Min Typ Max Unit V<sub>CC</sub> supply voltage 2.0 5.0 6.0 V Vı input voltage 0 V<sub>CC</sub> V output voltage 0 V Vo -V<sub>CC</sub> ambient temperature -40 +125 °C Tamb - $\Delta t / \Delta V$ input transition rise and fall rate  $V_{CC} = 2.0 V$ 625 ns/V \_ - $V_{CC} = 4.5 V$ -1.67 139 ns/V

74HC05 Q100 Product data sheet  $V_{CC} = 6.0 V$ 

-

-

ns/V

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## 9. Static characteristics

### Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to	o +125 ℃	Unit
			Min	Тур	Max	Min	Max	Min	Max	
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	$V_{CC} = 4.5 V$	3.15	2.4	-	3.15	-	3.15	-	V
		$V_{CC} = 6.0 V$	4.2	3.2	-	4.2	-	4.2	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	$V_{CC} = 4.5 V$	-	2.1	1.35	-	1.35	-	1.35	V
		$V_{CC} = 6.0 V$	-	2.8	1.8	-	1.8	-	1.8	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH} \text{ or } V_{IL}$								
output voltage	$I_{O} = 20 \ \mu A; V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V	
		$I_{O} = 20 \ \mu A; V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
	$I_{O}$ = 4.0 mA; $V_{CC}$ = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V	
		$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
l <sub>l</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±0.1	-	±1	-	±1	μA
I <sub>OZ</sub>	OFF-state output current	per input pin; $V_I = V_{IL}$ ; $V_O = V_{CC}$ or GND; other inputs at $V_{CC}$ or GND; $V_{CC} = 6.0$ V; $I_O = 0$ A	-	-	±0.5	-	±5.0	-	±10	μA
I <sub>CC</sub>	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} \text{ or } GND; \ I_{O} = 0 \ A; \\ V_{CC} = 6.0 \ V \end{array}$	-	-	2.0	-	20	-	40	μA
CI	input capacitance		-	3.5	-	-	-	-	-	pF

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## **10.** Dynamic characteristics

### Table 7. Dynamic characteristics

GND = 0 V; for test circuit see Figure 7.

Symbol	Parameter	Conditions			25 °C		-40 °C to	o +125 °C	Unit
				Min	Тур	Max	Max (85 °C)	Max (125 °C)	_
t <sub>PLZ</sub>	PLZ LOW to OFF-state	nA to nY; see Figure 6							
	propagation delay	$V_{CC} = 2.0 V$		-	20	90	115	135	ns
		$V_{CC} = 4.5 V$		-	11	18	23	27	ns
		$V_{CC} = 6.0 V$		-	10	15	20	23	ns
t <sub>PZL</sub>	t <sub>PZL</sub> OFF-state to LOW	nA to nY; see Figure 6							
propagation delay	propagation delay	$V_{CC} = 2.0 V$		-	22	90	115	135	ns
	$V_{CC} = 4.5 V$		-	9	18	23	27	ns	
	$V_{CC} = 6.0 V$		-	8	15	20	23	ns	
t <sub>THL</sub>	HIGH to LOW	see Figure 6							
	output transition	$V_{CC} = 2.0 V$		-	18	75	95	110	ns
time	$V_{CC} = 4.5 V$		-	6	15	19	22	ns	
		V <sub>CC</sub> = 6.0 V		-	5	13	16	19	ns
C <sub>PD</sub>	power dissipation capacitance	per inverter; V <sub>I</sub> = GND to V <sub>CC</sub> ; V <sub>CC</sub> = 5.0 V	<u>[1]</u>	-	4	-	-	-	pF

[1]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (0.5 \times C_{L} \times V_{O}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;

 $f_o = output frequency in MHz;$ 

 $V_O$  = output voltage in V (output HIGH);

 $V_{CC}$  = supply voltage in V;

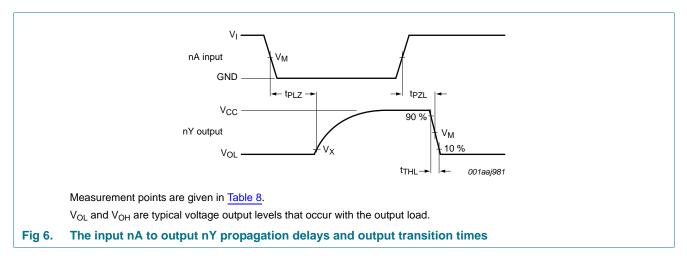
N = number of inputs switching;

 $R_L$  = load resistance in M $\Omega$ ;

 $C_L$  = load capacitance in pF;

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## 11. Waveforms



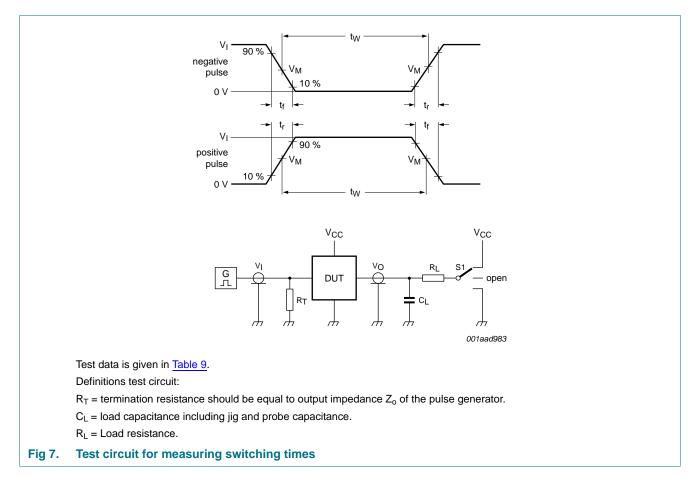
### Table 8. Measurement points

Input	Output	
V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>
0.5V <sub>CC</sub>	0.5V <sub>CC</sub>	0.1V <sub>CC</sub>

### **NXP Semiconductors**

# 74HC05-Q100

### Hex inverter with open-drain outputs

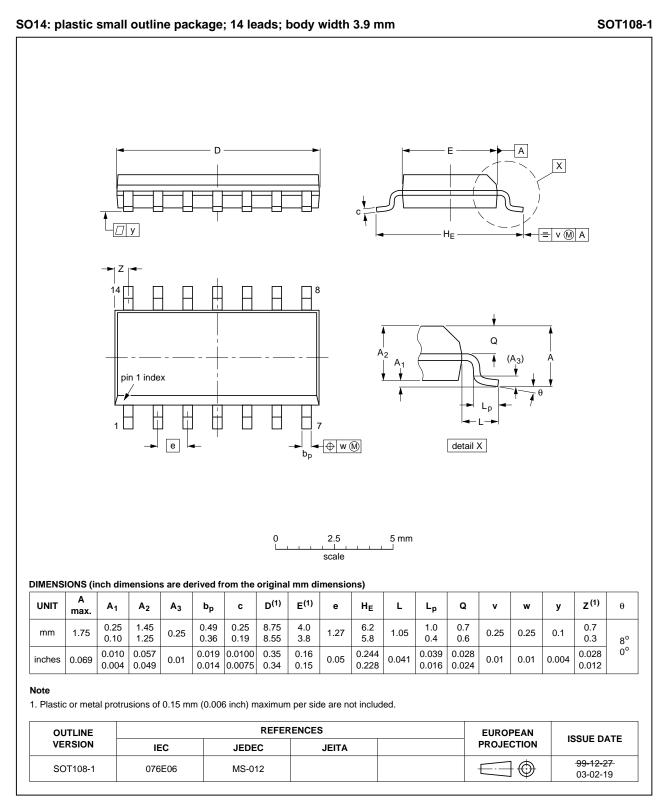


#### Table 9. Test data

Input		Load		S1 position	
VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PZL</sub> , t <sub>PLZ</sub>	
V <sub>CC</sub>	6 ns	50 pF	1 kΩ	V <sub>CC</sub>	

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## 12. Package outline



### Fig 8. Package outline SOT108-1 (SO14)

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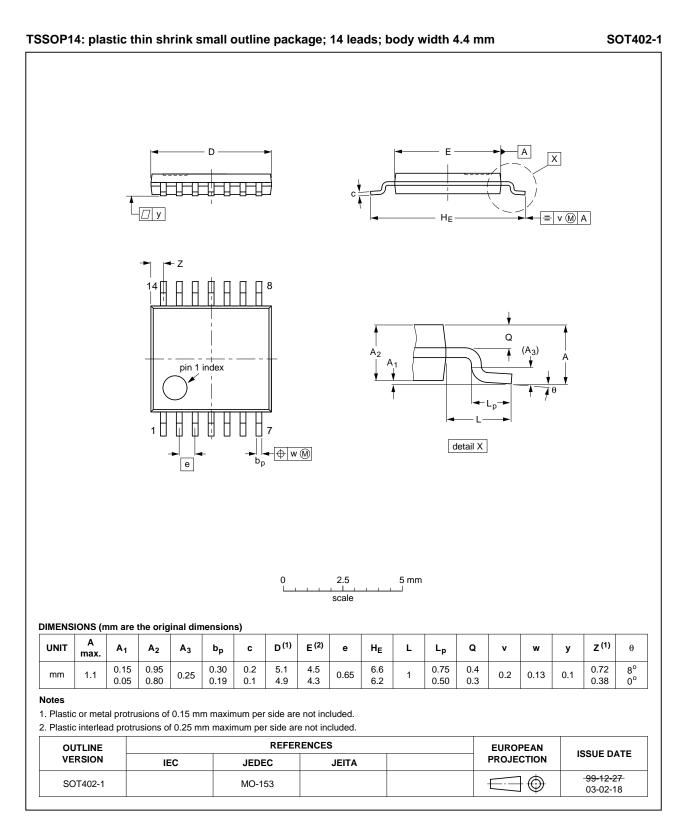
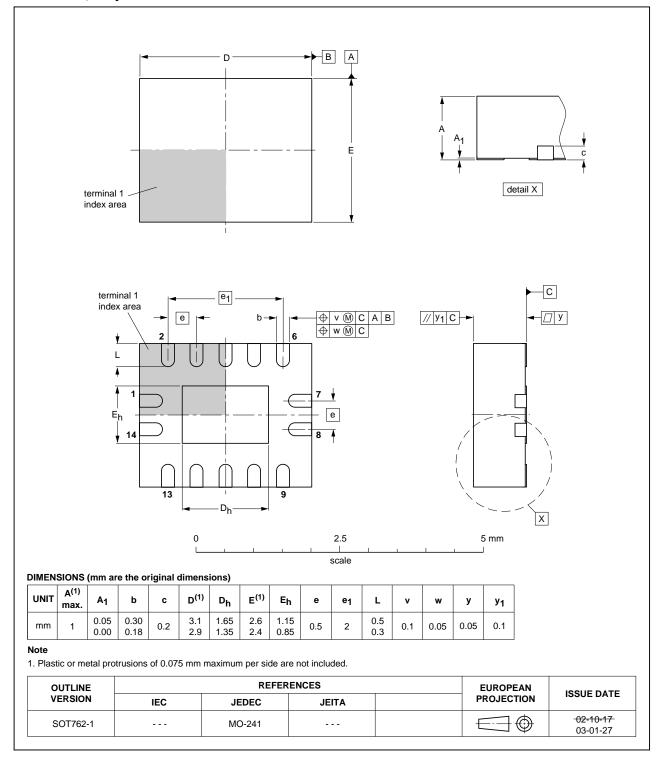


Fig 9. Package outline SOT402-1 (TSSOP14)

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DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

#### Fig 10. Package outline SOT762-1 (DHVQFN14)

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## **13. Abbreviations**

Table 10.	Abbreviations
Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model

# 14. Revision history

Table 11. Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC05_Q100_1	20120709	Product data sheet	-	-

#### Hex inverter with open-drain outputs

## **15. Legal information**

### 15.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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